2.0x1.25mm SMD CHIP LED LAMP



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

AP2012MBC

BLUE

Features

- •2.0mmx1.25mm SMT LED,1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.
- •Rohs Compliant.

Description

The Blue source color devices are made with GaN on SiC Light Emitting Diode.

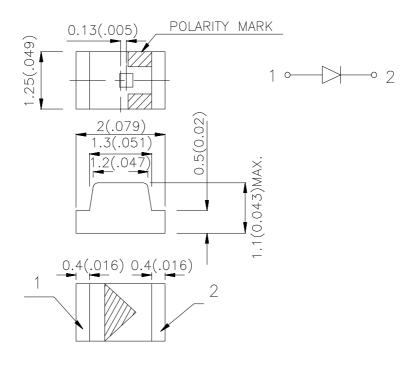
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or

anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. Specifications are subject to change without notice.

 SPEC NO: DSAD0942
 REV NO: V.3
 DATE: MAR/11/2005
 PAGE: 1 OF 4

 APPROVED: J. Lu
 CHECKED: Allen Liu
 DRAWN: Y.W.WANG
 ERP:1203000119

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA		Viewing Angle
			Min.	Тур.	201/2
AP2012MBC	BLUE (GaN)	WATER CLEAR	4	10	120°

Note:

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	430		nm	I _F =20mA
λD	Dominant Wavelength	Blue	466		nm	I _F =20mA
Δλ1/2	Spectral Line Half-width	Blue	60		nm	I _F =20mA
С	Capacitance	Blue	100		pF	V _F =0V;f=1MHz
V _F	Forward Voltage	Blue	3.8	4.5	V	I _F =20mA
I _R	Reverse Current	Blue		10	uA	$V_R = 5V$

Absolute Maximum Ratings at Ta=25°C

Parameter	Blue	Units	
Power dissipation	105	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating / Storage Temperature	-40°C To +85°C		

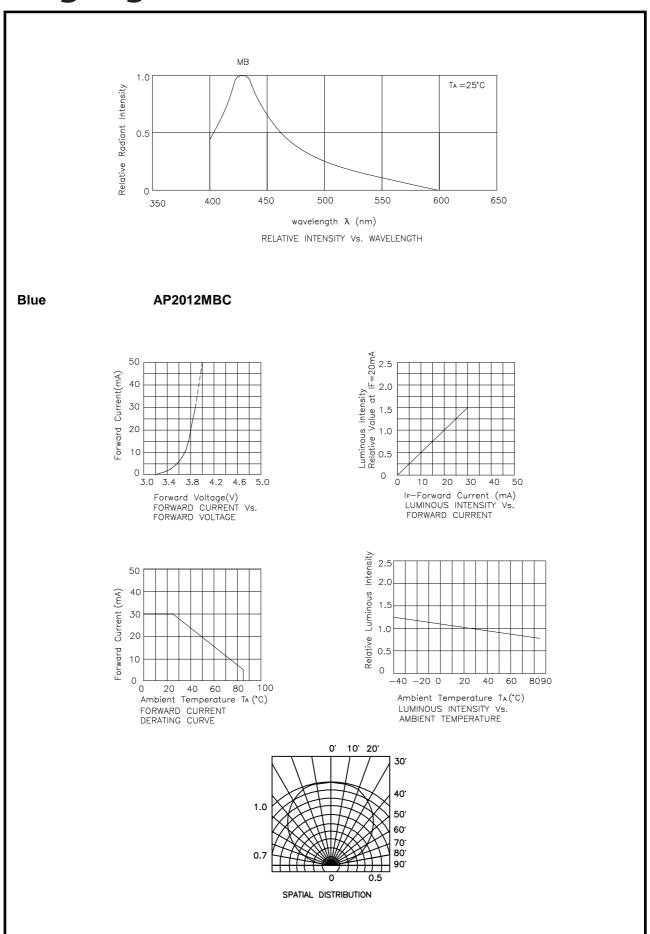
Note

 SPEC NO: DSAD0942
 REV NO: V.3
 DATE: MAR/11/2005
 PAGE: 2 OF 4

 APPROVED: J. Lu
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^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.



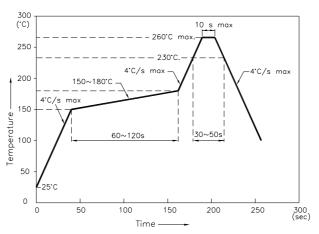
SPEC NO: DSAD0942 REV NO: V.3 DATE: MAR/11/2005
APPROVED: J. Lu CHECKED: Allen Liu DRAWN: Y.W.WANG

PAGE: 3 OF 4

ERP:1203000119

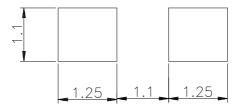
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Reflow Soldering Profile For Lead-free SMT Process.

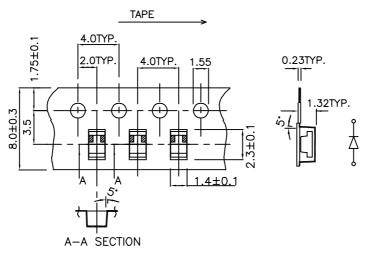


- NOTES: 1. We recommend the reflow temperature 245°C(\pm / \pm 5°C). The maximum soldering temperature should be limited to 260°C.
 - 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm)



Tape Specifications (Units: mm)



Remarks:

If there is sorting requirement (eg. forward voltage, luminous intensity or wavelength), the condition as follows:

- 1. Wavelength: +/-1nm (Test condition is based on the sorting standard).
- 2.Luminous intensity: +/-15% (Test condition is based on the sorting standard).
- 3. Forward voltage: +/-0.1V (Test condition is based on the sorting standard).

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